

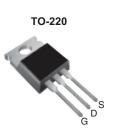
**Vishay Siliconix** 

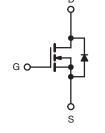
RoHS

COMPLIANT

### **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	250				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V	0.28			
Q <sub>g</sub> (Max.) (nC)	68				
Q <sub>gs</sub> (nC)	11				
Q <sub>gd</sub> (nC)	35				
Configuration	Single				





N-Channel MOSFET

### FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Lead (Pb)-free Available

#### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220
Lead (Pb)-free	IRF644PbF
	SiHF644-E3
SnPb	IRF644
	SiHF644

<b>ABSOLUTE MAXIMUM RATINGS</b> $T_C = 25 ^{\circ}C$ , unless otherwise noted						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V <sub>DS</sub>	250	v		
Gate-Source Voltage			V <sub>GS</sub>	± 20	V	
Continuous Drain Current	$V_{GS}$ at 10 V $T_{C} =$	$T_{C} = 25 °C$ $T_{C} = 100 °C$	- I <sub>D</sub>	14		
	V <sub>GS</sub> at 10 V	$T_C = 100 ^{\circ}C$		8.5	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	56		
Linear Derating Factor			1.0	W/°C		
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	550	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	14	А	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	13	mJ	
Maximum Power Dissipation	T <sub>C</sub> =	25 °C	P <sub>D</sub> 125		W	
Peak Diode Recovery dV/dtc			dV/dt 4.8		V/ns	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C		
Soldering Recommendations (Peak Temperature)	for	10 s		300 <sup>d</sup>		
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
				1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD} = 50 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ , L = 4.5 mH,  $R_G = 25 \Omega$ ,  $I_{AS} = 14 \text{ A}$  (see fig. 12).

c.  $I_{SD} \le 14$  A,  $dI/dt \le 150$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RA	TINGS							
PARAMETER	SYMBOL	TYP. MAX.			UNIT			
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 62 0.50 - 1.0						
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>				°C/W			
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>							
<b>SPECIFICATIONS</b> $T_J = 25 \ ^{\circ}C$ ,	unless otherw	vise noted						
PARAMETER	SYMBOL	1		IONS	MIN.	TYP.	MAX.	UNIT
Static	OTMDOL	120			IVIII V.		ШАЛ.	UNIT
Drain-Source Breakdown Voltage	V <sub>DS</sub>	Voo -	= 0 V, I <sub>D</sub> = 2	250	250	_	-	V
V <sub>DS</sub> Temperature Coefficient	ΔV <sub>DS</sub> /T <sub>J</sub>			, I <sub>D</sub> = 1 mA	-	0.34	-	v V/°C
Gate-Source Threshold Voltage				=	2.0	-		v/ c v
5	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$			2.0	-	4.0	-
Gate-Source Leakage	I <sub>GSS</sub>	$V_{GS} = \pm 20 \text{ V}$			-	-	± 100	nA
Zero Gate Voltage Drain Current I <sub>DSS</sub>		_	$V_{DS} = 250 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-	25	μA
Drain-Source On-State Resistance	В	$V_{DS} = 200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$ $V_{GS} = 10 \text{ V} \qquad \text{I}_{D} = 8.4 \text{ A}^{b}$		-	-	250	-	
Forward Transconductance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	= 50 V, I <sub>D</sub> =			-	0.28	Ω
	9 <sub>fs</sub>	V <sub>DS</sub> =	= 50 V, I <sub>D</sub> =	• 0.4 A°	6.7	-	-	S
Dynamic		1		-	r	1000	r	
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$		-	1300	-	pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 25 V,$			-	330		-
Reverse Transfer Capacitance	C <sub>rss</sub>	t = 1.	0 MHz, se	e fig. 5	-	85	-	ļ
Total Gate Charge	Qg			-	-	68		
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	-	A, $V_{DS} = 200 V$ ,	-	-	11	nC
Gate-Drain Charge	Q <sub>gd</sub>	-	see fig. 6 and 13 <sup>b</sup>		-	-	35	
Turn-On Delay Time	t <sub>d(on)</sub>				-	11	-	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 125 V, I <sub>D</sub> = 7.9 A, R <sub>G</sub> = 9.1 Ω, R <sub>D</sub> = 8.7 Ω, see fig. 10 <sup>b</sup>		-	24	-	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	53	-		
Fall Time	t <sub>f</sub>			-	49	-		
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH	
Internal Source Inductance	L <sub>S</sub>			-	7.5	-		
Drain-Source Body Diode Characteristic	cs					1		
Continuous Source-Drain Diode Current	١ <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	14	A	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	56		
Body Diode Voltage	V <sub>SD</sub>	$T_J = 25 \ ^{\circ}C, I_S = 14 \ A, V_{GS} = 0 \ V^b$		-	-	1.8	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = 7.9 \text{ A}, dl/dt = 100 \text{ A}/\mu\text{s}^{b}$		-	250	500	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	2.3	4.6	μC	
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$ )						

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300  $\mu s;$  duty cycle  $\leq$  2 %.



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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

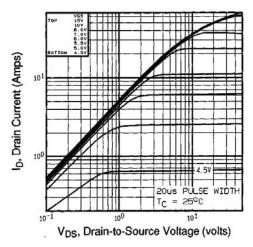


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

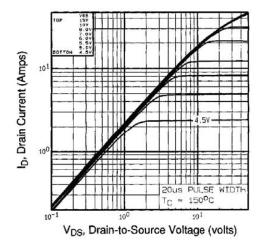


Fig. 2 - Typical Output Characteristics,  $T_C = 150$  °C

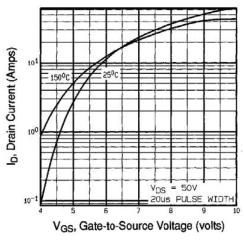


Fig. 3 - Typical Transfer Characteristics

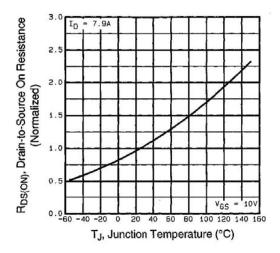


Fig. 4 - Normalized On-Resistance vs. Temperature

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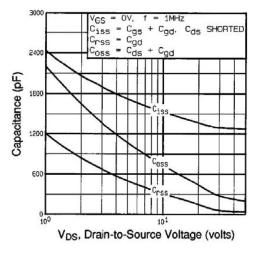


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

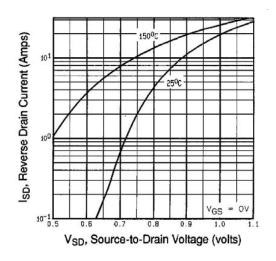


Fig. 7 - Typical Source-Drain Diode Forward Voltage

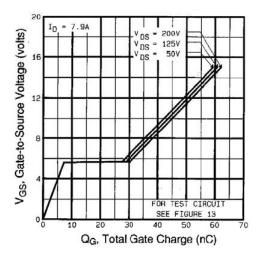


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

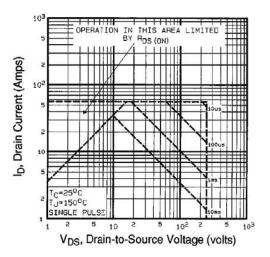
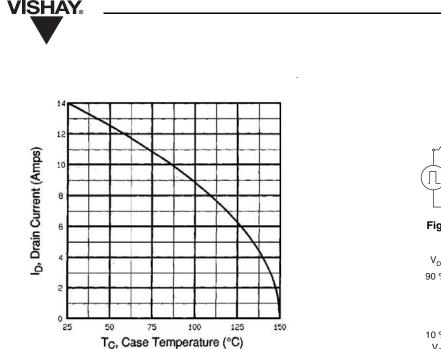


Fig. 8 - Maximum Safe Operating Area





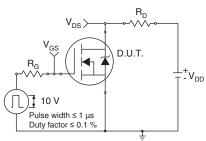


Fig. 10a - Switching Time Test Circuit

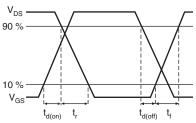
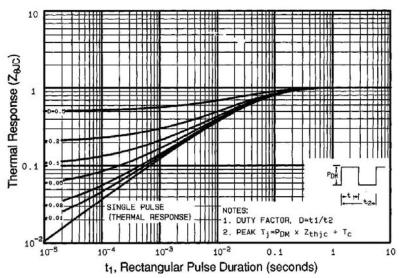


Fig. 10b - Switching Time Waveforms





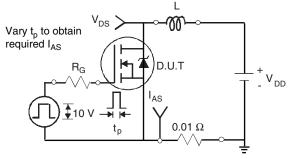
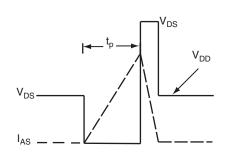
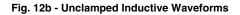


Fig. 12a - Unclamped Inductive Test Circuit





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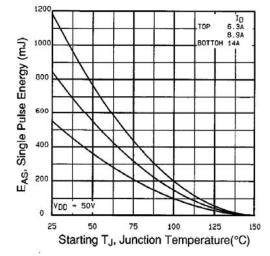


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

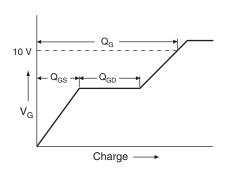
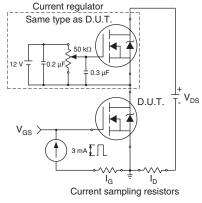


Fig. 13a - Basic Gate Charge Waveform

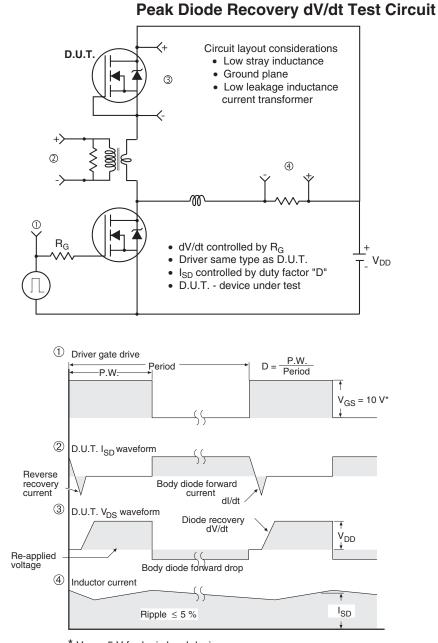






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\*  $V_{GS} = 5$  V for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?91039.



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